# DuPont 5091D/5092D/5093D

PTC THERMISTOR COMPOSITION

#### **Technical Data Sheet**

## **Product Description**

DuPont 5091D, DuPont 5092D and DuPont 5093D positive temperature coefficient (PTC) Thermistor compositions are intended for making PTC Thermistor in thick film microcircuits using conventional thick film processing. Potential include temperature applications temperature compensation elements, heaters.

#### **Product Benefits**

- Linear dependence of resistance with temperature
- Compatibility with thick film processing
- Bendability
- High positive TCR
- Laser trim stability
- **Environmental stability**

## **Processing Substrates**

Properties are based on tests on 96% alumina substrates. Substrates of other compositions and from various manufacturers may result in variations in performance properties.

# **Typical Physical Properties**

Test	Properties
Viscosity (Pa.S) (Brookfield HAT, UC&SP, 10 rpm, 25°C)	150 - 250
Thinner	DuPont 4553

Table 1 shows anticipated typical physical properties for DuPont 5091D, 5092D & 5093D based on specific controlled experiments in our labs and are not intended to represent the product specifications, details of which are available upon request.

#### **Terminations**

Reported properties are based on tests with 7484 Ag/Pd conductor composition, prefired at 850°C. Excellent results have also been obtained using Ag 6160, prefired at 850°C.

### **Printing**

Specified properties are based on resistors printed to 25±2 um dried print thickness. This is readily achieved using 200 -mesh stainless steel screens with 15±3 µm emulsion thickness.

#### **Drying**

Prints should be allowed to level 5-10 minutes at room temperature and then dried 10-15 minutes at 150°C.

Typical PTC Thermistor Properties			
	5091D	5092D	5093D
Resistivity <sup>1,2</sup> ( $\Omega$ /sq)	10	100	1000
Shipping Specification(%)	±10	±10	±20
Temperature Coefficient of Resistance <sup>3</sup> (ppm/°C)	3100 ± 200	3000 ± 200 (Hot) 3100 ± 200 (Cold)	2750 ± 250
Post Laser Trim Stability <sup>4</sup> (%) 25°C/1000 hours 85%RH/85°C/1000 hours 150°C/1000 hours	<0.3 <0.2 <0.3	<0.2 <0.2 <0.2	<0.2 <0.2 <0.2

Terminations Ag/PD 7484; Substrate 96% alumina; Printing 200-mesh stainless steel screen (15±3 µm emulsion thickness) to a dried thickness of 25±2 µm; Firing - recommended short firing profile to a peak emperature of 850°C for 10 minutes.

Resistor geometry for R, TCR, laser trim stability: 1.5 x 1.5 mm

Cold TCR measured from –55 to +25°C Hot TCR measured from +25 to +125°C Post Laser trim stability

This data is based on tests of 1.5 x 1.5 mm resistor resistors trimmed to 1.5 x initial value with a single plunge cut. All resistors were un-encapsulated.

#### **Firing**

Resistivity and TCR specifications are based on the recommended 30 minutes firing profile with a 10 minute peak at 850°C. Slight variation in resistance and TCR will occur when longer firing profiles or higher peak temperature are used. See Figure 1

## **Encapsulation**

In general, glass encapsulation is not required. However, for applications in need of mechanical protection or protection from extreme environments such as high temperature nitrogen or forming gas, encapsulant 9137, 9537 or QQ550 fired at 500 °C is recommended.

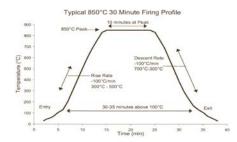
# Storage and Shelf Life

Containers should be stored, tightly sealed, in a clean, stable environment at room temperature (<25°C). Shelf life of material in unopened containers is six months from date of shipment. Some settling of solids may occur and compositions should be thoroughly mixed prior to use.

## Safety and Handling

For Safety and Handling information pertaining to this product, read the Material Safety Data Sheet (MSDS).

## Figure 1 - 30 Minutes Profile



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For more information on DuPont 5091D, 5092D & 5093D or other DuPont Microcircuit Materials products, please contact your local representative:

#### Americas

DuPont Microcircuit Materials

14 T.W. Alexander Drive

Research Triangle Park, NC 27709

Tel.: 800-284-3382

#### Europe

Du Pont (U.K.) Limited Coldharbour Lane Bristol BS16 1QD

U.K

Tel.: 44-117-931-3191

#### <u>Asia</u>

DuPont Kabushiki Kaisha Sanno Park Tower, 11-1 Nagata-cho 2-chome Chiyoda-ku, Tokyo 100-611

Japan

Tel.: 81-3-5521-8650

DuPont Taiwan Ltd 45, Hsing-Pont Road, Taoyuan, Taiwan 330 Tel.: 886-3-377-3616

DuPont China Holding Co. Ltd
Bldg 11, 399 Keyuan Rd., Zhangji Hi-Tech Park,
Pudong New District, Shanghai 201203, China
Tel.: 86-21-6386-6366 ext.2202

#### DuPont Korea Inc.

3~5th Floor, Asia tower #726, Yeoksam-dong, Gangnam-gu Seoul 135-719, Korea Tel.: 82-10-6385-5399

E. I. DuPont India Private Limited
7th Floor, Tower C, DLF Cyber Greens,
Sector-25A, DLF City, Phase-III,
Gurgaon 122 002 Haryana, India
Tel.: 91-124-4091818

Du Pont Company (Singapore) Pte Ltd 1 HarbourFront Place, #11-01 HarbourFrong Tower One, Singapore 098633

Tel.: 65-6586-3022

http://mcm.dupont.com

